

Fast IGBT in NPT-technology with soft, fast recovery anti-parallel Emitter Controlled Diode

- 75% lower *E*_{off} compared to previous generation combined with low conduction losses
- \bullet Short circuit withstand time 10 μs
- Designed for:
 - Motor controls
 - Inverter
- NPT-Technology for 600V applications offers:
 - very tight parameter distribution
 - high ruggedness, temperature stable behaviour
 - parallel switching capability
- Very soft, fast recovery anti-parallel Emitter Controlled
 Diode
- Pb-free lead plating; RoHS compliant
- Qualified according to JEDEC¹ for target applications
- Complete product spectrum and PSpice Models : http://www.infineon.com/igbt/

| Туре | V _{CE} | I _C | V _{CE(sat)} | Tj | Marking | Package |
|----------|-----------------|----------------|----------------------|-------|---------|---------------|
| SKP04N60 | 600V | 4A | 2.3V | 150°C | K04N60 | PG-TO-220-3-1 |

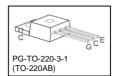
Maximum Ratings

| Parameter | Symbol | Value | Unit |
|---|-----------------------------|---------|------|
| Collector-emitter voltage | V _{CE} | 600 | V |
| DC collector current | I _C | | А |
| $T_{\rm C} = 25^{\circ}{\rm C}$ | | 9.4 | |
| $T_{\rm C} = 100^{\circ}{\rm C}$ | | 4.9 | |
| Pulsed collector current, t_p limited by T_{jmax} | I _{Cpuls} | 19 | |
| Turn off safe operating area | - | 19 | |
| $V_{CE} \le 600 \text{V}, \ T_j \le 150^{\circ} \text{C}$ | | | |
| Diode forward current | I _F | | |
| $T_{\rm C} = 25^{\circ}{\rm C}$ | | 10 | |
| $T_{\rm C} = 100^{\circ}{\rm C}$ | | 4 | |
| Diode pulsed current, t_p limited by T_{jmax} | I _{Fpuls} | 19 | |
| Gate-emitter voltage | V _{GE} | ±20 | V |
| Short circuit withstand time ² | t _{sc} | 10 | μS |
| $V_{\rm GE}$ = 15V, $V_{\rm CC} \le 600$ V, $T_{\rm j} \le 150^{\circ}$ C | | | |
| Power dissipation | P _{tot} | 50 | W |
| $T_{\rm C} = 25^{\circ}{\rm C}$ | | | |
| Operating junction and storage temperature | $T_{\rm j}$, $T_{\rm stg}$ | -55+150 | °C |
| Soldering temperature | Ts | 260 | °C |
| wavesoldering, 1.6 mm (0.063 in.) from case for 10s | | | |

¹ J-STD-020 and JESD-022

² Allowed number of short circuits: <1000; time between short circuits: >1s.







Thermal Resistance

| Parameter | Symbol | Conditions | Max. Value | Unit |
|---------------------------|-----------------|---------------|------------|------|
| Characteristic | | | | • |
| IGBT thermal resistance, | $R_{\rm thJC}$ | | 2.5 | K/W |
| junction – case | | | | |
| Diode thermal resistance, | $R_{\rm thJCD}$ | | 4.5 | |
| junction – case | | | | |
| Thermal resistance, | $R_{\rm thJA}$ | PG-TO-220-3-1 | 62 | |
| junction – ambient | | | | |

Electrical Characteristic, at T_j = 25 °C, unless otherwise specified

| | Cumhal | Conditions | Value | | | 11 |
|---|----------------------|--|-------|------|------|------|
| Parameter | Symbol | Conditions | min. | Тур. | max. | Unit |
| Static Characteristic | | · | | | | • |
| Collector-emitter breakdown voltage | $V_{(BR)CES}$ | $V_{\rm GE} = 0V, I_{\rm C} = 500 \mu A$ | 600 | - | - | V |
| Collector-emitter saturation voltage | V _{CE(sat)} | $V_{\rm GE} = 15 \rm V, \ I_{\rm C} = 4 \rm A$ | | | | |
| | | <i>T</i> _j =25°C | 1.7 | 2.0 | 2.4 | |
| | | <i>T</i> _j =150°C | - | 2.3 | 2.8 | |
| Diode forward voltage | V _F | $V_{GE}=0V, I_{F}=4A$ | | | | |
| | | T _j =25°C | 1.2 | 1.4 | 1.8 | |
| | | <i>T</i> _j =150°C | - | 1.25 | 1.65 | |
| Gate-emitter threshold voltage | V _{GE(th)} | $I_{\rm C} = 200 \mu {\rm A}, V_{\rm CE} = V_{\rm GE}$ | 3 | 4 | 5 | |
| Zero gate voltage collector current | I _{CES} | $V_{\rm CE} = 600 \rm V, V_{\rm GE} = 0 \rm V$ | | | | μA |
| | | T _j =25°C | - | - | 20 | |
| | | <i>T</i> _j =150°C | - | - | 500 | |
| Gate-emitter leakage current | I _{GES} | $V_{CE}=0V, V_{GE}=20V$ | - | - | 100 | nA |
| Transconductance | $g_{ m fs}$ | $V_{CE}=20V, I_{C}=4A$ | | 3.1 | - | S |
| Dynamic Characteristic | | | | | | |
| Input capacitance | Ciss | V _{CE} =25V, | - | 264 | 317 | pF |
| Output capacitance | Coss | $V_{\rm GE}=0V$, | - | 29 | 35 | |
| Reverse transfer capacitance | Crss | f=1MHz | - | 17 | 20 | |
| Gate charge | Q _{Gate} | $V_{\rm CC} = 480 \text{V}, I_{\rm C} = 4 \text{A}$ | - | 24 | 31 | nC |
| | | $V_{GE} = 15 V$ | | | | |
| Internal emitter inductance | LE | | - | 7 | - | nH |
| measured 5mm (0.197 in.) from case | | | | | | |
| Short circuit collector current ²⁾ | I _{C(SC)} | V_{GE} =15V, t_{SC} ≤10 μ s V_{CC} ≤600V, | - | 40 | - | A |
| | | $T_{\rm j} \leq 150^{\circ}{\rm C}$ | | | | |

 $^{2)}$ Allowed number of short circuits: <1000; time between short circuits: >1s.



Switching Characteristic, Inductive Load, at T_i =25 °C

| | Symbol | Conditions | Value | | | |
|--|-------------------------|---|-------|-------|-------|------|
| Parameter | | | min. | typ. | max. | Unit |
| IGBT Characteristic | | | | | | |
| Turn-on delay time | t _{d(on)} | $T_{j}=25^{\circ}C,$ $V_{CC}=400V, I_{C}=4A,$ $V_{GE}=0/15V,$ | - | 22 | 26 | ns |
| Rise time | t _r | | - | 15 | 18 | |
| Turn-off delay time | t _{d(off)} | $R_{\rm G}$ =67 Ω , | - | 237 | 284 | |
| Fall time | t _f | $L_{\sigma}^{(1)} = 180 \text{ nH},$ $C_{\sigma}^{(1)} = 180 \text{ pF}$ Energy losses include "tail" and diode reverse recovery. | - | 70 | 84 | |
| Turn-on energy | Eon | | - | 0.070 | 0.081 | mJ |
| Turn-off energy | E _{off} | | - | 0.061 | 0.079 | |
| Total switching energy | Ets | | - | 0.131 | 0.160 | |
| Anti-Parallel Diode Characteristic | | · | | | | |
| Diode reverse recovery time | t _{rr} | <i>T</i> _j =25°C, | - | 180 | - | ns |
| | ts | $V_{\rm R}$ =200V, $I_{\rm F}$ =4A, | - | 15 | - | |
| | t _F | di _F /dt=200A/µs | - | 165 | - | |
| Diode reverse recovery charge | Q _{rr} | | - | 130 | - | nC |
| Diode peak reverse recovery current | <i>I</i> _{rrm} | | - | 2.5 | - | А |
| Diode peak rate of fall of reverse recovery current during $t_{\rm b}$ | di _{rr} /dt | | - | 180 | - | A/μs |

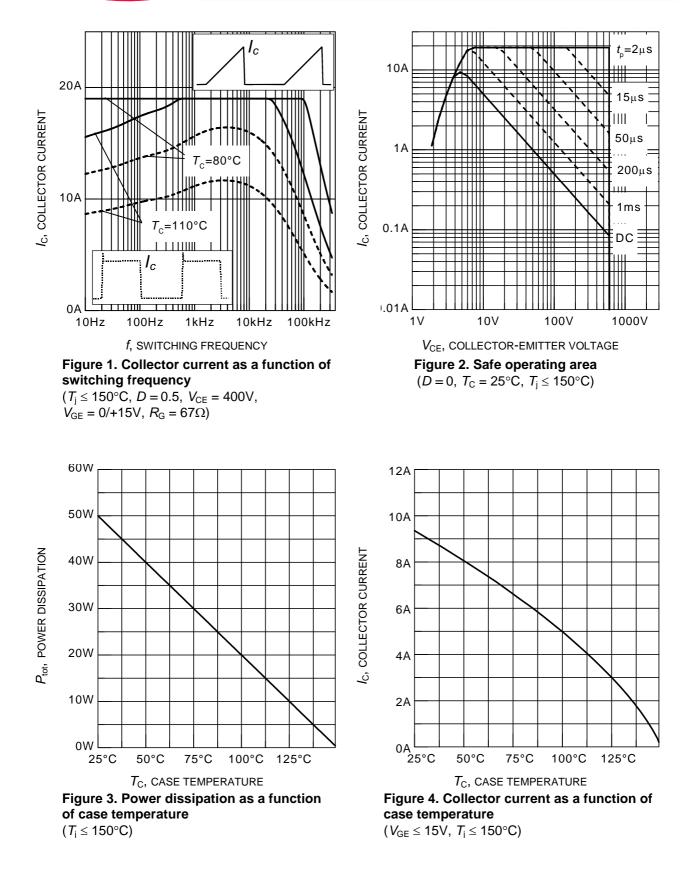
Switching Characteristic, Inductive Load, at T_j =150 °C

| | Symbol | Conditions | Value | | | 11 |
|--|-------------------------|---|-------|-------|-------|------|
| Parameter | | | min. | typ. | max. | Unit |
| IGBT Characteristic | | · · | | | | • |
| Turn-on delay time | t _{d(on)} | <i>T</i> _j =150°C | - | 22 | 26 | ns |
| Rise time | t _r | $V_{CC} = 400 V, I_{C} = 4A,$ $V_{GE} = 0/15 V,$ $R_{G} = 67 \Omega,$ | - | 16 | 19 | - |
| Turn-off delay time | t _{d(off)} | | - | 264 | 317 | |
| Fall time | t _f | $L_{\sigma}^{(1)} = 180 \text{ nH},$ | - | 104 | 125 | |
| Turn-on energy | Eon | $C_{\sigma}^{(1)} = 180 \text{ pF}$ Energy losses include "tail" and diode reverse recovery. | - | 0.115 | 0.132 | mJ |
| Turn-off energy | $E_{\rm off}$ | | - | 0.111 | 0.144 | |
| Total switching energy | Ets | | - | 0.226 | 0.277 | |
| Anti-Parallel Diode Characteristic | | | | | | |
| Diode reverse recovery time | t _{rr} | <i>T</i> _j =150°C | - | 230 | - | ns |
| | ts | $V_{\rm R}$ =200V, $I_{\rm F}$ =4A, | - | 23 | - | |
| | t _F | di _F /dt=200A/µs | - | 227 | - | |
| Diode reverse recovery charge | Q _{rr} | | - | 300 | - | nC |
| Diode peak reverse recovery current | <i>I</i> _{rrm} | | - | 4 | - | А |
| Diode peak rate of fall of reverse recovery current during $t_{\rm b}$ | di _{rr} /dt | | - | 200 | - | A/μs |

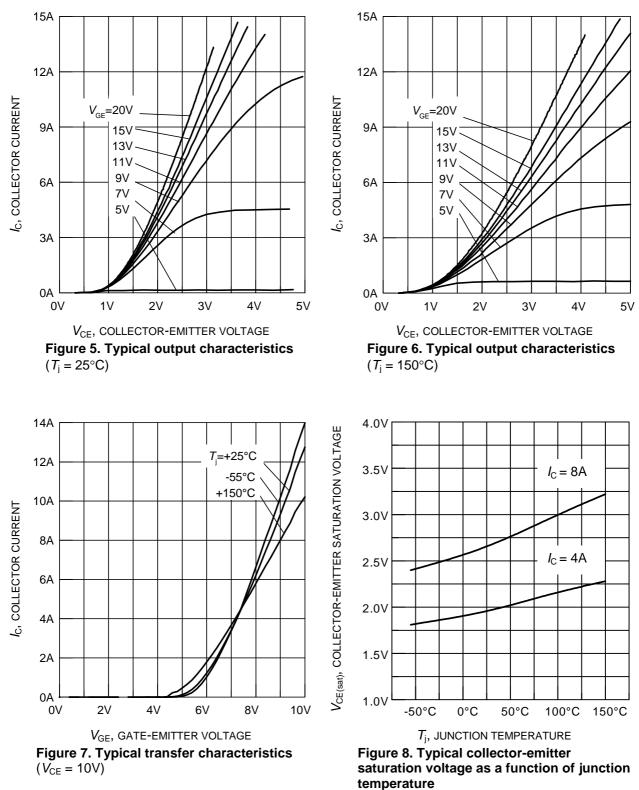
 $^{1)}$ Leakage inductance L_{σ} and Stray capacity C_{σ} due to dynamic test circuit in Figure E.





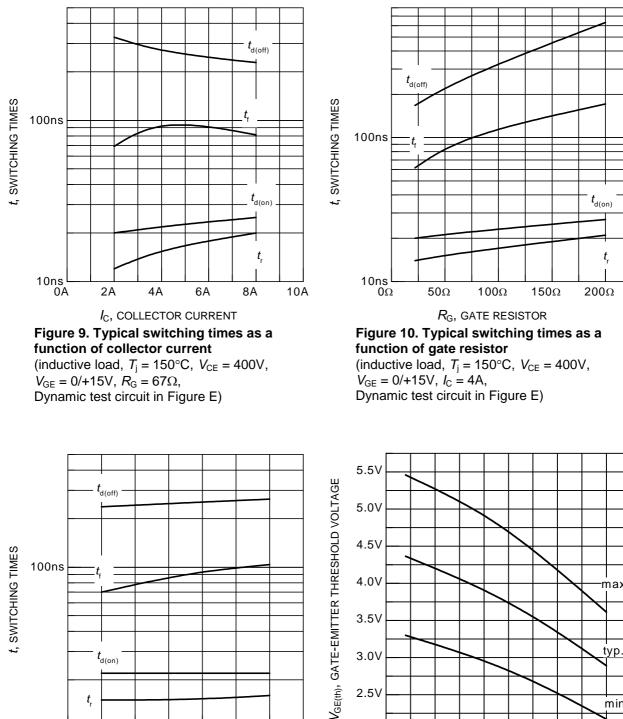


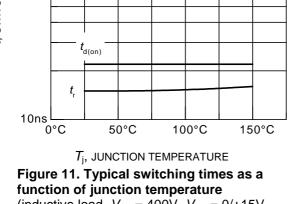




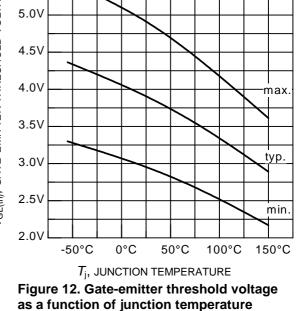
 $(V_{\rm GE} = 15V)$







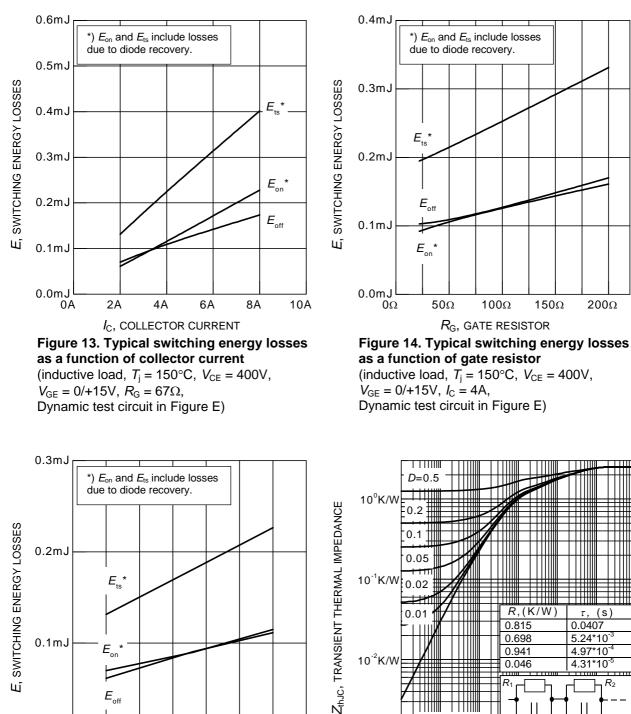
(inductive load, $V_{CE} = 400V$, $V_{GE} = 0/+15V$, $I_{\rm C} = 4 {\rm A}, R_{\rm G} = 67 \Omega,$ Dynamic test circuit in Figure E)

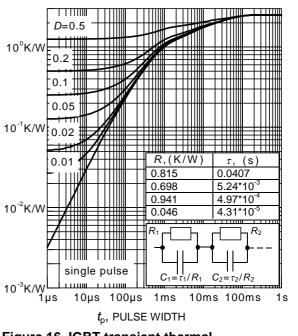


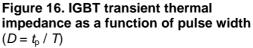
 $(I_{\rm C} = 0.2 {\rm mA})$

200Ω









 $E_{\rm off}$

50°C

Dynamic test circuit in Figure E)

 $T_{\rm i}$, JUNCTION TEMPERATURE Figure 15. Typical switching energy losses

as a function of junction temperature

(inductive load, $V_{CE} = 400V$, $V_{GE} = 0/+15V$,

100°C

150°C

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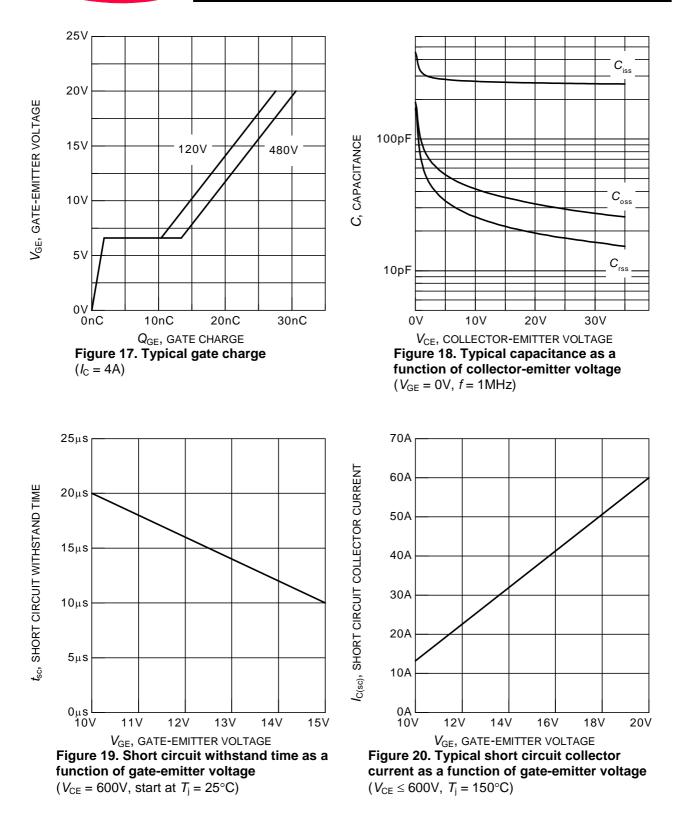
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0.0mJ

õ°C

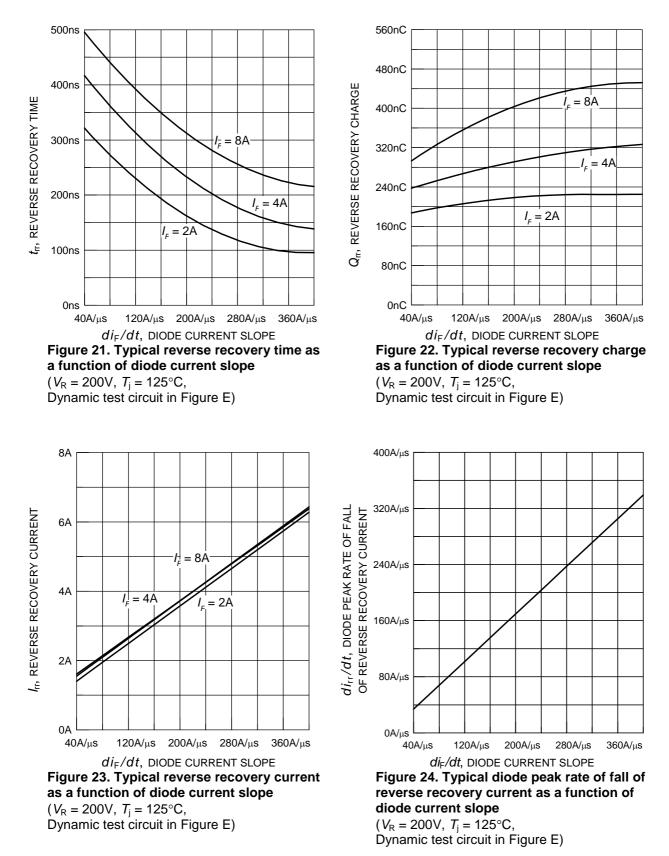
 $I_{\rm C} = 4 {\rm A}, R_{\rm G} = 67 \Omega,$



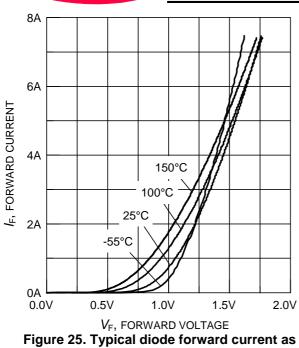


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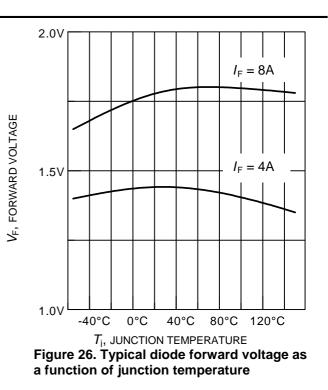


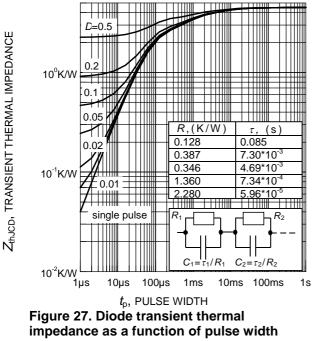






a function of forward voltage

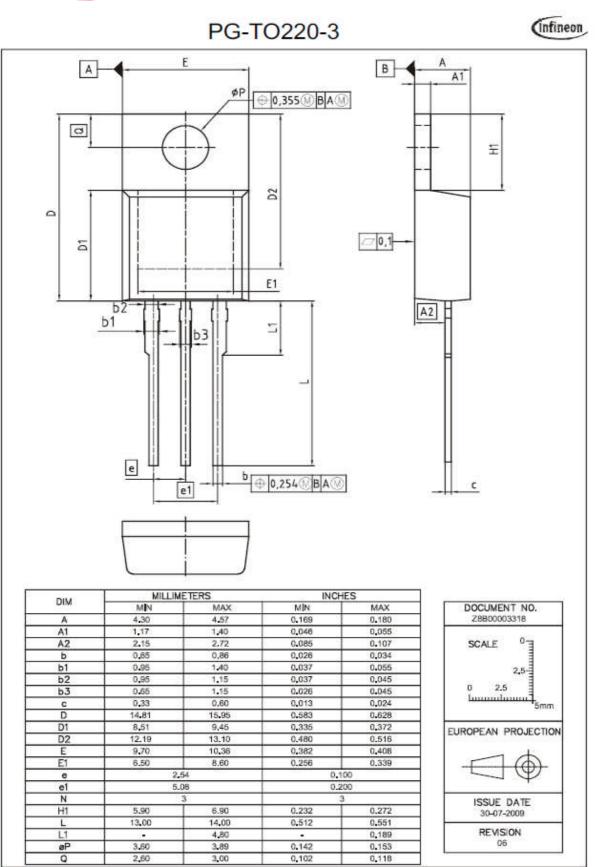






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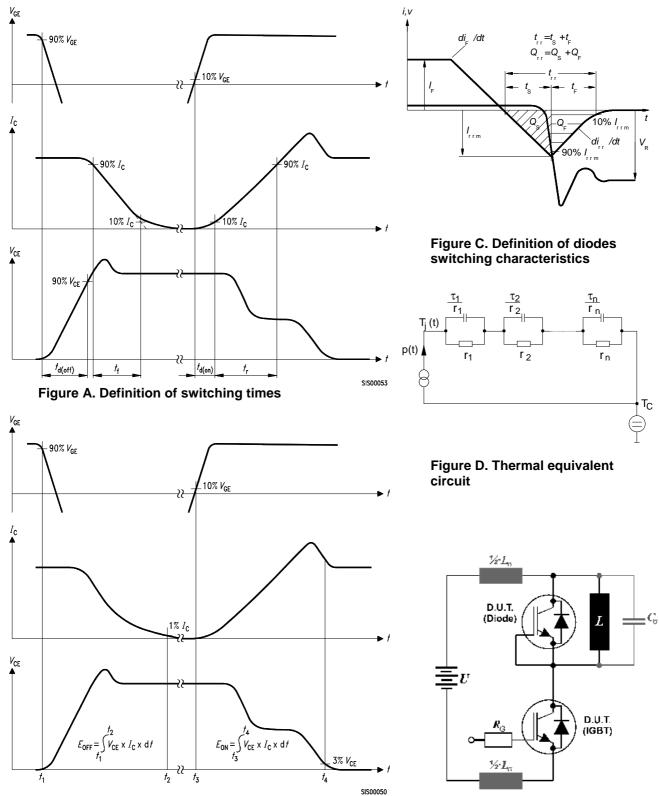
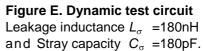


Figure B. Definition of switching losses





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